

#### CX3VSM CRYSTAL

18 kHz to 600 kHz

Miniature Surface Mount Quartz Crystal for Pierce Oscillators

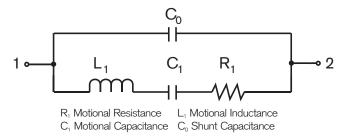
#### **DESCRIPTION**

The CX3VSM quartz crystals are leadless devices designed for surface mounting on printed circuit boards or hybrid substrates. These miniature crystals are intended to be used in Pierce oscillators. They are hermetically sealed in a rugged, miniature ceramic package. They are manufactured using the STATEKdeveloped photolithographic process, and were designed utilizing the experience acquired by producing millions of crystals for industrial, commercial, military and medical applications. Maximum process temperature should not exceed 260°C.

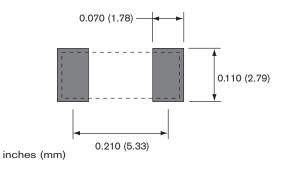
#### **FEATURES**

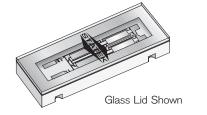
- Miniature tuning fork design
- High shock resistance
- Designed for low power applications
- Compatible with hybrid or PC board packaging
- Low aging
- Full military testing available
- Ideal for battery operated applications
- Designed and manufactured in the USA

#### **EQUIVALENT CIRCUIT**



#### SUGGESTED LAND PATTERN

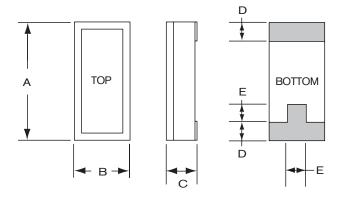




# actual size

side view

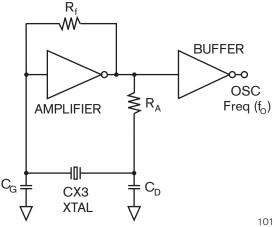
#### PACKAGE DIMENSIONS



	ΙY	'P.	IVIA	ЧX.	
DIM	inches	mm	inches	mm	
Α	0.263	6.68	0.270	6.86	
В	0.097	2.46	0.104	2.64	
С	-	-	see	below	
D	0.052	1.32	0.058	1.47	
Е	0.030	0.76	0.035	0.89	

DIM "C""	GLASS	LID	CERAMIC	LID
MAX	inches	mm	inches	mm
SM1	0.053	1.35	0.067	1.70
SM2/SM4	0.055	1.40	0.069	1.75
SM3/SM5	0.058	1.47	0.072	1.83

#### CONVENTIONAL CMOS PIERCE OSCILLATOR CIRCUIT





#### **SPECIFICATIONS**

Specifications are typical at 25°C unless otherwise noted.

Specifications are subject to change without notice.

Frequency Range 18 kHz to 600 kHz
Functional Mode Tuning Fork (Flexure)
Standard Calibration Tolerance (see table below)

Motional Resistance ( $R_1$ ) See Figure 1

MAX.: 18-25 kHz, 2x Typ. 25-600 kHz, 2.5x Typ.

Motional Capacitance (C<sub>1</sub>) Figure 2 Quality Factor (Q) Figure 3

MIN is 0.25x Typ.

Shunt Capacitance ( $C_0$ ) 1.8 pF MAX

Drive Level 18-24.9 kHz 0.5 μW MAX.

 $25\text{-}600~\text{kHz}~1.0~\mu\text{W}$  MAX.

Turning Point  $(T_0)^2$  Figure 4 Temperature Coefficient (k)  $-0.035 \text{ ppm}/^{\circ}\text{C}^2$ 

Aging, first year 5 ppm MAX

Shock, survival<sup>3</sup> 1,500 g peak, 0.3 ms, 1/2 sine
Vibration, survival<sup>3</sup> 10 g RMS, 20-2,000 Hz random
Operating Temp. Range -10°C to +70°C (Commercial)

-40°C to +85°C (Industrial) -55°C to +125°C (Military)

Storage Temp. Range -55°C to +125°C Max Process Temperature 260°C for 20 sec.

- 1. Tighter frequency calibration available.
- 2. Other turning point available.
- 3. Higher shock and vibration available.

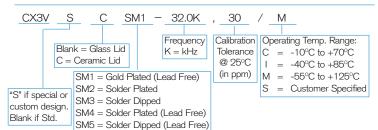
#### CX3V Standard Calibration Tolerance at 25°C

	Frequency I	Range (kHz)	
18-74.9	75-169.9	170-249.9	250-600
± 30 ppm	± 50 ppm	± 100 ppm	±200 ppm
(0.003%)	(0.005%)	(0.01%)	(0.02%)
± 100 ppm	± 100 ppm	± 200 ppm	±500 ppm
(0.01%)	(0.01%)	(0.02%)	(0.05%)
± 1000 ppm	± 1000 ppm	± 2000 ppm	±5000 ppm
(0.1%)	(0.1%)	(0.2%)	(0.5%)

## Load Capacitance ( $C_L$ ), Used to Calibrate CX3V (other $C_L$ available)

Frequency Range (kHz)	Load Capacitance (pF)	Frequency Range (kHz)	Load Capacitance (pF)
18-24.9	10	100.1-179.9	5
25-54.9	9	180-600	4
55-100.0	8		

#### HOW TO ORDER CX3VSM CRYSTALS



### FIGURE 1 CX3V TYPICAL MOTIONAL RESISTANCE ( $R_1$ )

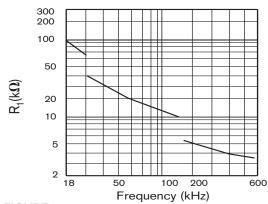
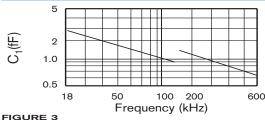


FIGURE 2
CX3V TYPICAL MOTIONAL CAPACITANCE (C,)



CX3V TYPICAL QUALITY FACTOR (Q)

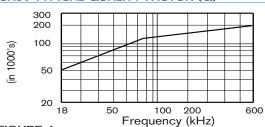
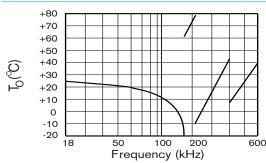


FIGURE 4
CX3V TYPICAL TURNING POINT TEMP. (T<sub>o</sub>)



Note: Frequency f at temperature T is related to frequency  $f_0$  at turning point temperature  $T_0$  by:  $\frac{f - f_0}{r} = k \left(T - T_0\right)^2$ 

#### **TERMINATIONS**

<u>Designation</u>	<u>Termination</u>
SM1	Gold Plated (Lead Free)
SM2	Solder Plated
SM3	Solder Dipped
SM4	Solder Plated (Lead Free)
SM5	Solder Dipped (Lead Free)

#### PACKAGING OPTIONS

CX3VSM - Tray Pack

- Tape and Reel

(Reference tape and reel data sheet 10109)

10104 - Rev C

